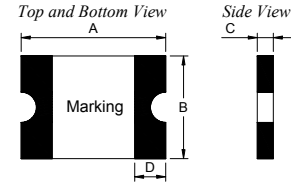


## 1、 Physical Dimensions(size of 1206)

Unit:mm

Part Number	A		B		C		D	Marking
	Min	Max	Min	Max	Min	Max	Min	
K1206L020/30YR	3.00	3.40	1.40	1.80	0.60	1.00	0.25	T02



## 2、 Electrical Characteristics

Part Number	I <sub>H</sub> (A)	I <sub>T</sub> (A)	V <sub>max</sub> (V)	I <sub>max</sub> (A)	T <sub>trip</sub> (Max time to trip)		Pd <sub>typ</sub> (W)	R <sub>min</sub> (Ω)	R1 <sub>max</sub> (Ω)
					Current(A)	Time(S)			
K1206L020/30YR	0.20	0.46	30	60	1.00	0.60	0.60	0.600	3.300

I<sub>H</sub>: Holding Current: maximum current at which the device will not trip in 25°C still air.

I<sub>T</sub>: Tripping Current minimum current at which the device will trip in 25°C still air.

V<sub>max</sub>: Maximum voltage device can withstand without damage at rated current.

I<sub>max</sub>: Maximum fault current device can withstand without damage at rated voltage.

T<sub>trip</sub>: Maximum time to trip(s) at assigned current.

Pd<sub>typ</sub>: Rated working power.

R<sub>min</sub>: Minimum resistance of device prior to trip at 25°C.

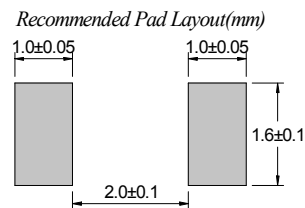
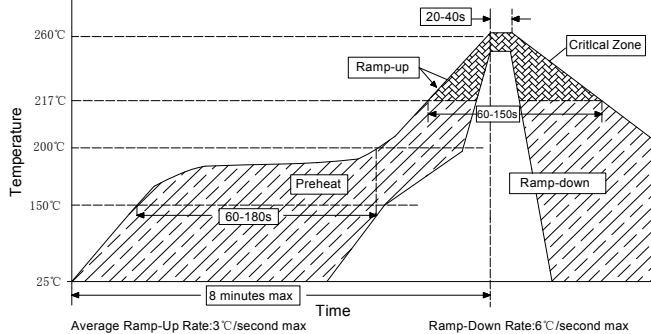
R1<sub>max</sub>: Maximum resistance of device is measured one hours post reflow at 25°C.

Noted: All electrical function test is conducted after PCB mounted.

## 3、 Thermal Derating

K1206L020/30YR	Maximum ambient operating temperature								
	-40°C	-20°C	0°C	25°C	40°C	50°C	60°C	70°C	85°C
Hold Current(A)	0.30	0.27	0.24	0.20	0.18	0.16	0.14	0.12	0.11
Trip Current(A)	0.69	0.62	0.55	0.46	0.41	0.37	0.32	0.28	0.25

## 4、 Solder Reflow Recommendations



Notes: If reflow temperatures exceed the recommended profile, devices may not meet the performance requirements.

## 5、 Package Information

Packing quantity: 4000PCS/Reel

Note: Reel packaging per EIA-481-1 standard